

SFP

ESBxx31-3LCD20

3.072Gb/s SFP BIDI 20km Optical Transceiver Module

- Up to 3.072Gb/s data links
- 1310nm DFB laser transmitter and PIN photo-detector
- Up to 20km on 9/125μm SMF
- Hot-pluggable SFP footprint
- BIDI LC/UPC type pluggable optical interface
- Low power dissipation
- Metal enclosure, for lower EMI
- RoHS-10 compliant and lead-free
- Support Digital Diagnostic Monitoring interface
- Single +3.3V power supply
- Compliant with SFF-8472
- Case operating temperature
 - Commercial: 0 ~ +70°C
 - Extended: -10 ~ +80°C
 - Industrial: -40 ~ +85°C



Applications

- Switch to Switch Interface
- Gigabit Ethernet
- Switched Backplane Applications
- Router/Server Interface
- Other Optical Links

Description

Small Form Factor Pluggable (SFP) transceivers are compatible with the Small Form Factor Pluggable Multi-Sourcing Agreement (MSA). The transceiver consists of five sections: the LD driver, the limiting amplifier, the digital diagnostic monitor, the DFB laser and the PIN photo-detector. The module data link up to 20km in 9/125um single mode fiber.

The optical output can be disabled by a TTL logic high-level input of Tx Disable, and the system also

can disable the module via I2C. Tx Fault is provided to indicate that degradation of the laser. Loss of signal (LOS) output is provided to indicate the loss of an input optical signal of receiver or the link status with partner. The system can also get the LOS (or Link)/Disable/Fault information via I2C register access.

Absolute Maximum Ratings

It has to be noted that the operation in excess of any individual absolute maximum ratings might cause permanent damage to this module.

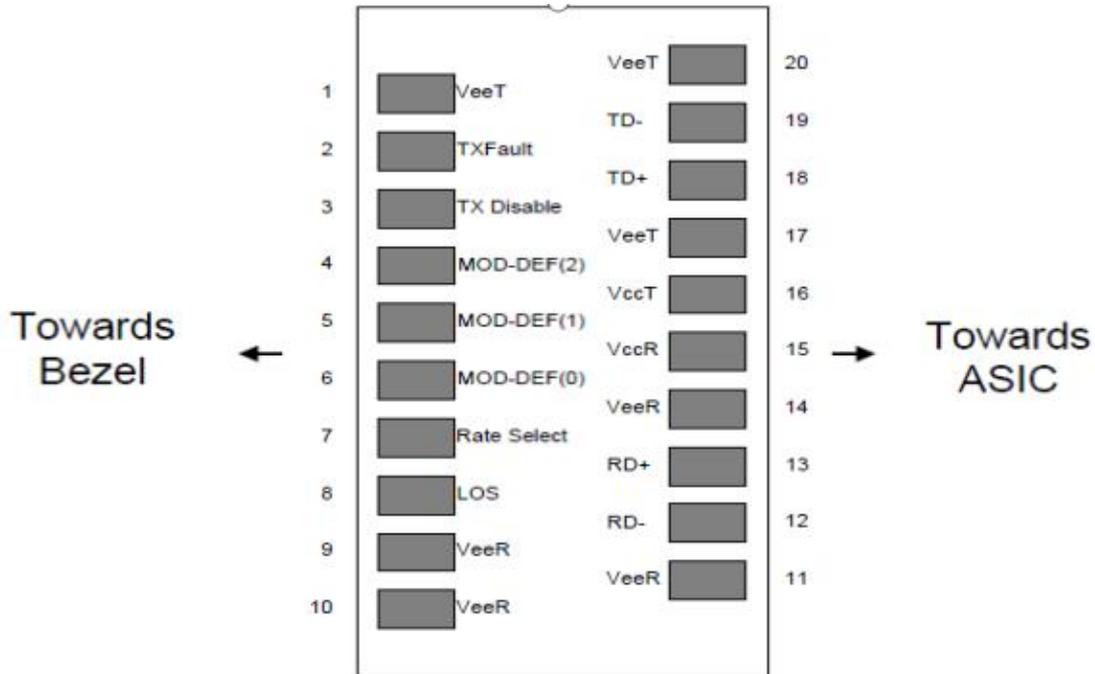
Parameter	Symbol	Min	Max	Unit	Notes
Storage Temperature	T _s	-40	85	°C	
Power Supply Voltage	V _{CC}	-0.3	3.6	V	
Relative Humidity (non-condensation)	RH	5	95	%	
Damage Threshold	TH _d	5		dBm	

Recommended Operating Conditions and Power Supply Requirements

Parameter	Symbol	Min	Typical	Max	Unit	Notes
Operating Case Temperature	T _{OP}	0		70	°C	commercial
		-10		80		extended
		-40		85		industrial
Power Supply Voltage	V _{CC}	3.135	3.3	3.465	V	
Data Rate			3.072		Gb/s	
Control Input Voltage High		2		V _{CC}	V	

Control Input Voltage Low		0		0.8	V	
Link Distance (SMF)	D			20	km	9/125um

Pin Assignment and Pin Description



PIN	Name	Name/Description	Notes
1	VEET	Transmitter Ground (Common with Receiver Ground)	1
2	TXFAULT	Transmitter Fault.	
3	TXDIS	Transmitter Disable. Laser output disabled on high or open.	2
4	MOD_DEF(2)	Module Definition 2. Data line for Serial ID.	3
5	MOD_DEF(1)	Module Definition 1. Clock line for Serial ID.	3
6	MOD_DEF(0)	Module Definition 0. Grounded within the module.	3
7	Rate Select	No connection required	4
8	LOS	Loss of Signal indication. Logic 0 indicates normal operation.	5
9	VEER	Receiver Ground (Common with Transmitter Ground)	1
10	VEER	Receiver Ground (Common with Transmitter Ground)	1
11	VEER	Receiver Ground (Common with Transmitter Ground)	1
12	RD-	Receiver Inverted DATAout. AC Coupled	
13	RD+	Receiver Non-inverted DATAout. AC Coupled	

14	VEER	Receiver Ground (Common with Transmitter Ground)	1
15	VCCR	Receiver Power Supply	
16	VCCT	Transmitter Power Supply	
17	VEET	Transmitter Ground (Common with Receiver Ground)	1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled.	
19	TD-	Transmitter Inverted DATA in. AC Coupled.	
20	VEET	Transmitter Ground (Common with Receiver Ground)	1

Notes:

1. Circuit ground is internally isolated from chassis ground.
2. Laser output disabled on TDIS >2.0V or open, enabled on TDIS <0.8V.
3. Should be pulled up with 4.7k-10k ohms on host board to a voltage between 2.0V and 3.6V. MOD_DEF (0) pulls line low to indicate module is plugged in.
4. This is an optional input used to control the receiver bandwidth for compatibility with multiple data rates (most likely Fiber Channel 1x and 2x Rates). If implemented, the input will be internally pulled down with > 30kΩ resistor. The input states are:
 - 1) Low (0 – 0.8V): Reduced Bandwidth
 - 2) (>0.8, < 2.0V): Undefined
 - 3) High (2.0 – 3.465V): Full Bandwidth
 - 4) Open: Reduced Bandwidth
5. LOS is open collector output should be pulled up with 4.7k-10k ohms on host board to a voltage between 2.0V and 3.6V. Logic 0 indicates normal operation; logic 1 indicates loss of signal.

Electrical Characteristics

The following electrical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min.	Typical	Max	Unit	Notes
Power Consumption	P			0.95	W	commercial
				1.00		Industrial

Supply Current	I _{cc}			280	mA	commercial
				300		Industrial
Transmitter						
Single-ended Input Voltage Tolerance	V _{CC}	-0.3		4.0	V	
Differential Input Voltage Swing	V _{in,pp}	200		2400	mVpp	
Differential Input Impedance	Z _{in}	90	100	110	Ohm	
Transmit Disable Assert Time				5	us	
Transmit Disable Voltage	V _{dis}	V _{CC} -1.3		V _{CC}	V	
Transmit Enable Voltage	V _{en}	V _{EE} -0.3		0.8	V	
Receiver						
Differential Output Voltage Swing	V _{out,pp}	500		900	mVpp	
Differential Output Impedance	Z _{out}	90	100	110	Ohm	
Data output rise/fall time	Tr/Tf		100		ps	20% to 80%
LOS Assert Voltage	V _{losH}	V _{CC} -1.3		V _{CC}	V	
LOS De-assert Voltage	V _{losL}	V _{EE} -0.3		0.8	V	

Optical Characteristics

The following optical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min.	Typical	Max	Unit	Notes
Transmitter						
Center Wavelength	λ_c	1290	1310	1330	nm	
Spectrum Bandwidth(RMS)	σ			1	nm	
Side Mode Suppression Ratio	SMSR	30			dB	
Average Optical Power	P _{AVG}	-5		0	dBm	1

Optical Extinction Ratio	ER	7			dB	
Transmitter OFF Output Power	POff				-45	dBm
Transmitter Eye Mask		Compliant with G.959(class 1 laser safety)				
Receiver						
Center Wavelength	λ_c	1530	1550	1570	nm	
Receiver Sensitivity (Average Power)	Sen.				-18	dBm
Input Saturation Power (overload)	Psat	-1				dBm
LOS Assert	LOSA	-36				dB
LOS De-assert	LOSD				-19	dBm
LOS Hysteresis	LOSH	0.5	2	6		dBm

Notes:

1. Measure at 2²³-1 NRZ PRBS pattern
2. Measured with Light source 1310nm, ER=7.0dB; BER =<10⁻¹² @PRBS=2²³-1 NRZ
3. When LOS de-asserted, the RX data+/- output is High-level (fixed).

Digital Diagnostic Functions

The following digital diagnostic characteristics are defined over the Recommended Operating Environment unless otherwise specified. It is compliant to SFF-8472 Rev10.2 with internal calibration mode. For external calibration mode please contact our sales staff.

Parameter	Symbol	Min.	Max	Unit	Notes
Temperature monitor absolute error	DMI_Temp	-3	3	degC	Over operating temp
Supply voltage monitor absolute error	DMI_VCC	-0.15	0.15	V	Full operating range
RX power monitor absolute error	DMI_RX	-3	3	dB	
Bias current monitor	DMI_bias	-10%	10%	mA	
TX power monitor absolute error	DMI_TX	-3	3	dB	

Mechanical Dimensions

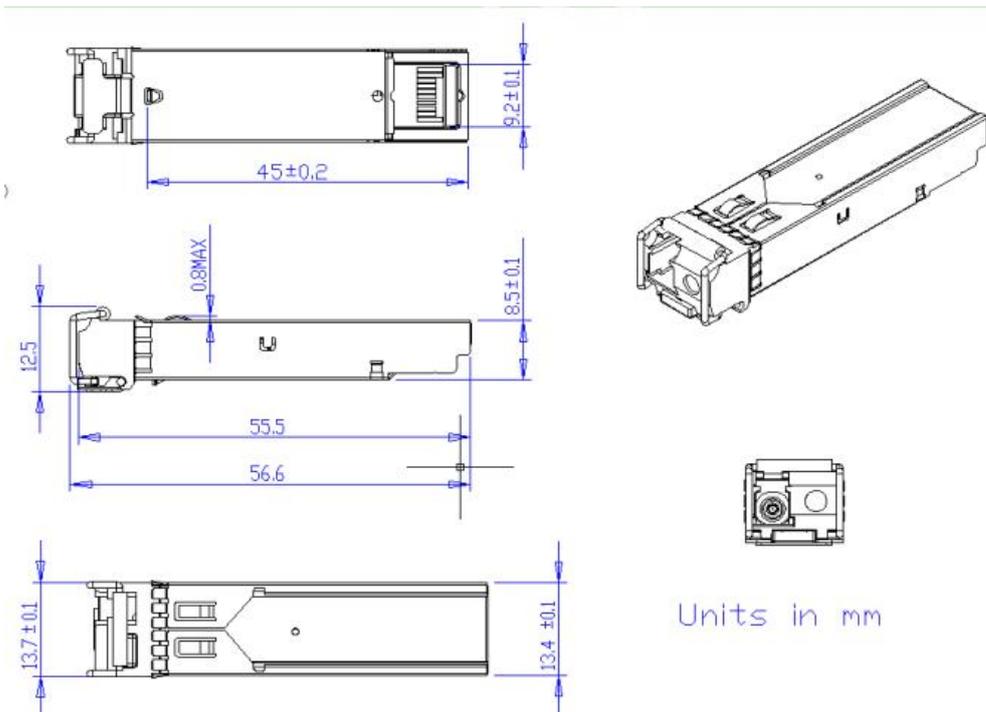


Figure2. Mechanical Outline

Precautions

- a. This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.
- b. Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

Compatibility Test

In order to ensure the product compatibility, our products will be tested on the switch before shipment. Our modules can compatible with many mainstream brand switches, such as Cisco, Juniper, Extreme, Brocade, IBM, H3C, HP, Huawei, D-Link, Mikrotik, ZTE, TP-Link...

Our test equipment: VOLKTEK MEN-4110, HP 2530-8G, CRS226-24G-25+RM, Catalyst 2960G Series, Catalyst 3850 XS 10G SFP+, Catalyst 3750-E Series, HUAWEI S5700Series, H3C S3100V2 Series, Juniper-EX4200, etc.



Cisco Catalyst 3850



HUAWEI S5700



H3C S3100V2



HP J9264AR



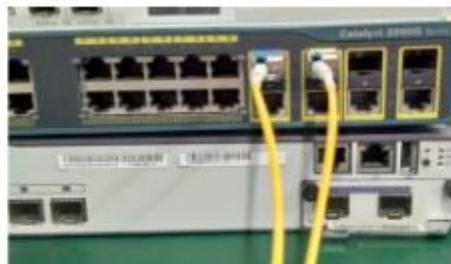
Juniper EX 4200



Alcatel 6850E-U24X



Mikrotik CR5226-24G-25+RM



Cisco Catalyst 2960G



Volktek MEN-4110

Quality Assurance

Continuous introduction of new equipment, produced by strict standards, strict quality inspection, to guarantee the high quality standard of each product.



**Standardized
Production Line**



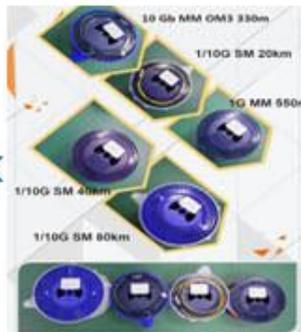
**Professional
Welding**



Assembling



Aging Testing



Distance Testing



Cleaning end face



Product Initial Test



Switch Testing



Product Final Test

Packaging

ETU-Link provides two kinds of packaging, 10pcs/Tray and individual package.



Company: ETU-Link Technology Co., LTD

Address: Right side of 3rd floor, No. 102 building, Longguan expressway, Dalang street,
Longhua District, Shenzhen city, GuangDongProvince,China 518109

Tel: +86-755 2328 4603

Addresses and phone number also have been listed at www.etulinktechnology.com.

Please e-mail us at sales@etulinktechnology.com or call us for assistance.